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PATENTS ONLY

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To the Honorable Commissioner of Patents and Trademarks	Please record the attached original documents or copy thereof	
Name of conveying party(ies):	Name and address of receiving party(ies)	
Atsushi Saitoh (02/28/2003), Hidemasa Iwami (02/28/2003), Shinichi Tamura (02/28/2003), and Hidek Imura (03/04/2003)	Internal Address:	
Additional name(s) of conveying party(ies) Yes X No attached?	Street Address: (A170) Intellectual Property Department	
3. Nature of Conveyance:	26-10, Tenjin 2-chome, Nagaokakyo-shi	
x Assignment Merger		
Security Agreement Change of Name	City: Kyoto-fu	
Other	Country: <u>JP</u> Zip: <u>617-8555</u>	
Execution Date: see Box 1, conveying parties	Additional name(s) & Yes X No address(es) attached:	
Application number(s) or patent number(s):		
If this document is being filed together with a new application, the A. Patent Application No.(s): 10/294,758	execution date of the new application is: B. Patent No.(s):	
Additional numbers attac	ched? Yes x No	
Name and address of party to whom correspondence concerning document should be mailed:	Total number of applications and patents involved: 1	
Name: Richard LaCava DICKSTEIN SHAPIRO MORIN & OSHINSKY LL	P 7. Total fee (37 CFR 3.41) \$ 40.00	
Internal Address: Atty. Dkt.: M1071.1796/P1796	Enclosed	
Street Address:	Authorized to be charged to deposit account	
1177 Avenue of the Americas 41st Floor	Authorized to be charged to credit card (Form 2038 enclosed)	
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City: State: Zip: New York NY 10036-2714	50-2215	
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9. Statement and signature. To the best of my knowledge and belief, the foregoing ir is a true copy of the original document. Richard LaCava	nformation is true and correct and any attached copy April 2, 2003	
Name of Person Signing	Signature Date	
Total number of pages including cover sheet, atta	achments, and documents: 2	
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04/07/2003

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PATENT REEL: 013927 FRAME: 0395 WHEREAS, We, Atsushi SAITOH, Hidemasa IWAMI, Shinichi TAMURA, and Hideki IMURA, as assignors, have invented certain improvements in DIELECTRIC LINE, HIGH FREQUENCY CIRCUIT AND HIGH FREQUENCY APPARATUS or which an application for United States Letters Patent has been executed by us of even date herewith; and

WHEREAS, MURATA MANUFACTURING COMPANY, LTD., as assignee, is desirous of acquiring all right, title and interest in and to said invention and any Patent that may be granted therefor.

NOW, THEREFORE, in consideration of One Dollar (\$1.00) and other good and valuable consideration, the receipt of which is hereby acknowledged, We, as assignors, hereby sell, assign and set over to said assignee the entire right, title and interest for the United States and all other countries in and to said invention and the aforesaid application for Patent, all original, divisional, continuation, substitute or reissue applications and patents applied for or granted therefor in the United States and all other countries, including all rights of priority from the filing of said application, and all rights for past infringement, and the Commissioner of Patents and Trademarks is hereby authorized and requested to issue all patents on said inventions or resulting therefrom to said assignee herein, as assignee of the entire interest therein; and the undersigned for ourselves and our legal representatives, heirs and assigns do hereby agree and covenant without further remuneration, to execute and deliver all divisional, continuation, reissue and other applications for Patent on said inventions and all assignments thereof to said assignee or its assigns, to communicate to said assignee or its representatives all facts known to the undersigned respecting said inventions, whenever requested, to testify in any interferences or other legal proceedings in which any of said applications or patents may become involved, to sign all lawful papers, make all rightful oaths, and to do generally everything necessary to assist assignee, its successors, assigns and nominees to obtain patent protection for said invention in the United States and all other countries, the expenses incident to said applications to be borne and paid by said assignee.

Date: _	2/28/2013	ATSUSHI SAITOH
·	ÁTSUSHÍ SAITÓH	
Date: 2/28 / 2013	Hidimasa Luami	
	HIDEMASA IWAMI	
Date: $\frac{2/28/2003}{}$	2/28/2003	Skinichi Tamura
	SHINICHI TAMURA	
Date: 3/4/2003	3/4/2003	Hideki Imura
	HIDEKI IMURA	

LEGALIZATION RECOMMENDED

RECORDED: 04/02/2003